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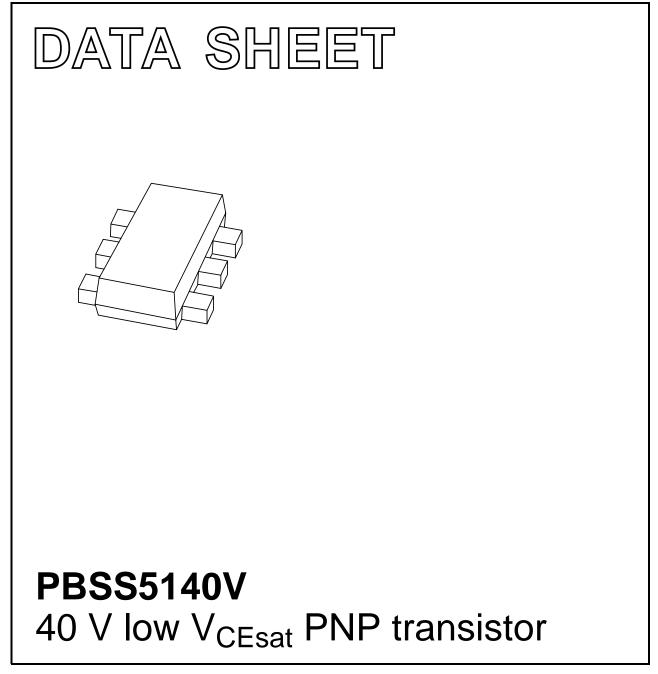
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2001 Oct 19 2002 Mar 20



40 V low V_{CEsat} PNP transistor

PBSS5140V

FEATURES

- 300 mW total power dissipation
- Very small 1.6 mm \times 1.2 mm \times 0.55 mm ultra thin package
- · Improved thermal behaviour due to flat leads
- · Self alignment during soldering due to straight leads
- · Low collector-emitter saturation voltage
- High current capability

APPLICATIONS

- General purpose switching and muting
- LCD back lighting
- Supply line switching circuits
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

DESCRIPTION

PNP low $V_{CE sat}$ transistor in a SOT666 plastic package. NPN complement: PBSS4140V.

MARKING

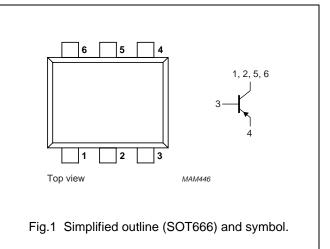
TYPE NUMBER	MARKING CODE			
PBSS5140V	25			

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V _{CEO}	collector-emitter voltage	-40	V	
I _C	collector current (DC)	-1	А	
I _{CM}	peak collector current	-2	А	
R _{CEsat}	equivalent on-resistance <340 mΩ		mΩ	

PINNING

PIN	DESCRIPTION
1	collector
2	collector
3	base
4	emitter
5	collector
6	collector



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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	-	-40	V
V _{EBO}	emitter-base voltage	open collector	_	-5	V
I _C	collector current (DC)		_	-1	А
I _{CM}	peak collector current		-	-2	А
I _B	base current (DC)		_	-300	mA
I _{BM}	peak base current		_	-1	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C; note 1$	-	300	mW
		$T_{amb} \le 25 \ ^{\circ}C$; note 2	_	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a printed-circuit board, single side copper, tinplated and standard footprint.
- 2. Device mounted on a printed-circuit board, single side copper, tinplated and mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	410	K/W
		note 2	215	K/W

Notes

- 1. Device mounted on a printed-circuit board, single side copper, tinplated and standard footprint.
- 2. Device mounted on a printed-circuit board, single side copper, tinplated and mounting pad for collector 1 cm².

Soldering

The only recommended soldering is reflow soldering.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -40 \text{ V}; \text{ I}_{E} = 0$	_	_	-100	nA
		$V_{CB} = -40 \text{ V}; \text{ I}_{E} = 0; \text{ T}_{amb} = 150 ^{\circ}\text{C}$	_	_	-50	μA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_B = 0$	_	_	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ mA}$	300	-	-	
		$V_{CE} = -5 \text{ V}; I_C = -100 \text{ mA}$	300	_	800	
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -500 \text{ mA}$	250	_	_	
		$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	160	_	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -100 \text{ mA}; I_{B} = -1 \text{ mA}$	_	-80	-140	mV
		I _C = -500 mA; I _B = -50 mA	_	-120	-170	mV
		$I_{\rm C} = -1$ A; $I_{\rm B} = -100$ mA	_	-200	-310	mV
R _{CEsat}	equivalent on-resistance	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ note } 1$	_	240	<340	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -50$ mA	_	_	-1.1	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	_	_	-1	V
f _T	transition frequency	$I_{C} = -50 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz	150	_	-	MHz
Cc	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	-	-	12	pF

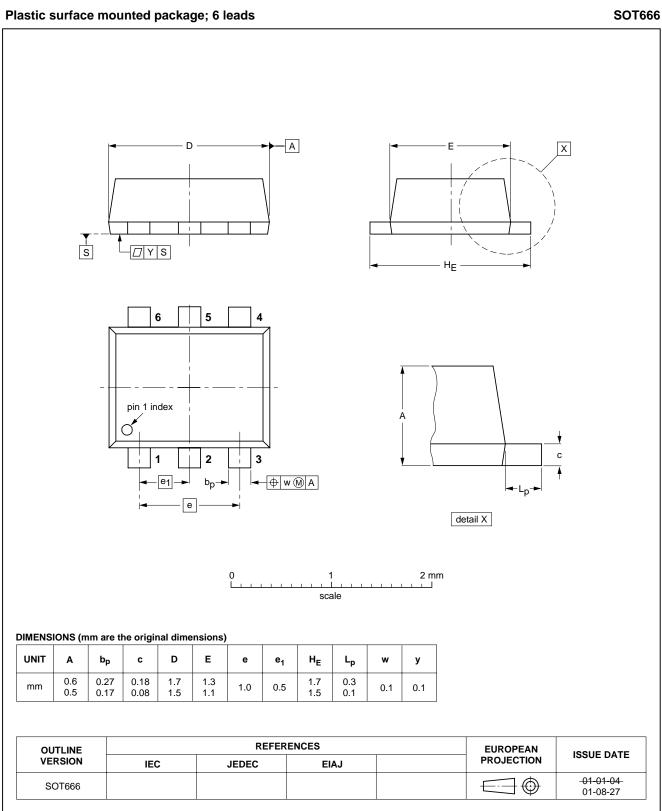
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

PBSS5140V

40 V low V_{CEsat} PNP transistor

PACKAGE OUTLINE



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40 V low V_{CEsat} PNP transistor

PBSS5140V

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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NXP Semiconductors

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Contact information

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